General Description

The MAX1886 is a high-current operational transconductance amplifier. The MAX1886 is ideal for driving the backplane of an active matrix, dot inversion thin film transistor (TFT) liquid crystal display (LCD). The MAX1886's high >500mA peak-current drive capability provides fast response to pulsed load conditions. The MAX1886 is stable from 0.47 μ F to an unlimited amount of output capacitance.

The MAX1886 is available in the low-profile (1.1mm max) 5-pin Thin SOT23 package and fully specified over the -40°C to +85°C extended temperature range.

_Features

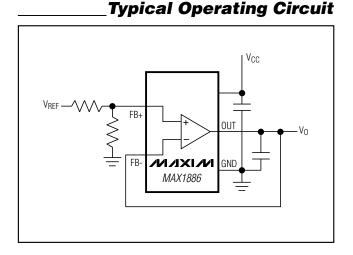
- Stable with 0.47µF to Unlimited Amount of Output Capacitance
- Over 500mA Peak Drive Current
- Excellent Settling Characteristics with Capacitive Load
- ♦ +4.5V to +13V Input Supply
- 0.45mA Quiescent Current
- Thermal Fault Protection
- Thin SOT23-5 Package (1.1mm max)

_Applications

Notebook LCD Panels Monitor LCD Panels

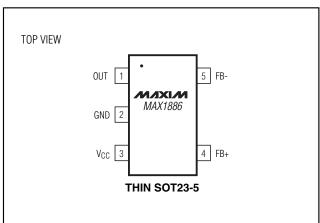
PART	TEMP. RANGE	PIN-PACKAGE	top Mark
MAX1886EZK	-40°C to +85°C	5 Thin SOT23-5*	ADQL

*Requires a special solder temperature profile described in the Absolute Maximum Ratings section.



Pin Configuration

Ordering Information



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

V _{CC} to GND0.3V to +14V	Operating Temperature Range40°C to +85°C
FB-, FB+, OUT to GND0.3V to (V _{CC} + 0.3V)	Junction Temperature+150°C
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	Storage Temperature Range65°C to +150°C
5-Pin Thin SOT23 (derate 7.1mW°C above +70°C)727mW	

This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board level solder attach and rework. Maxim recommends the use of the solder profiles recommended in the industry-standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow processes. Preheating, per this standard, is required. Hand or wave soldering is not recommended.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 10V, FB- = OUT, V_{FB+} = 5V, C_{OUT} = 0.47μ F, T_A = -40° C to $+85^{\circ}$ C, unless otherwise noted. Typical values are at T_A = $+25^{\circ}$ C.) (Note 1)

PARAMETER	SYMBOL	CONE	DITIONS	MIN	ТҮР	МАХ	UNITS	
V _{CC} Input Supply Range	V _{CC}			4.5		13	V	
V _{CC} Supply Current	Icc				450	900	μA	
Input Offset Voltage	Vos	$V_{FB+} = +5V$, no load	1	-5		5	mV	
Input Bias Current	IBIAS	1 0)/ c)/ou c 10 0	N/	-100		100	nA	
Input Offset Current	IOS	+1.2V < V _{CM} < +8.8	V	-100		100	nA	
Common-Mode Input Range	V _{CM}	V _{OS} < 10mV over C	CMR	1.2		V _{CC} - 1.2V	V	
Power-Supply Rejection Ratio	PSRR	+4.5V < V _{CC} < +13	/, V _{FB+} = +2.25V	70			dB	
Common-Mode Rejection Ratio	CMRR	+1.2V < V _{CM} < +8.8	3V	70			aв	
Gain-Bandwidth Product	GBW	Small signal			1/6πCL		Hz	
Transconductors		Small signal (±1mV	overdrive)		0.3		S	
Transconductance	Яm	Large signal (±30m)	/ overdrive)		10		5	
	La com	±100mV overdrive,	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	±175	±550			
Output Current Drive	IOUT	$V_{OUT} = 3V \text{ or } 7V$	$T_A = 0^{\circ}C \text{ to } +85^{\circ}C$	±250			mA	
Thermal Shutdown					170		°C	
Thermal Shutdown Hysteresis					15		°C	

Note 1: The MAX1886 is 100% production tested at $T_A = +25^{\circ}$ C. Specifications over temperature are guaranteed by design.

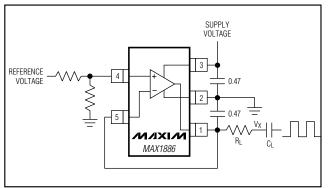
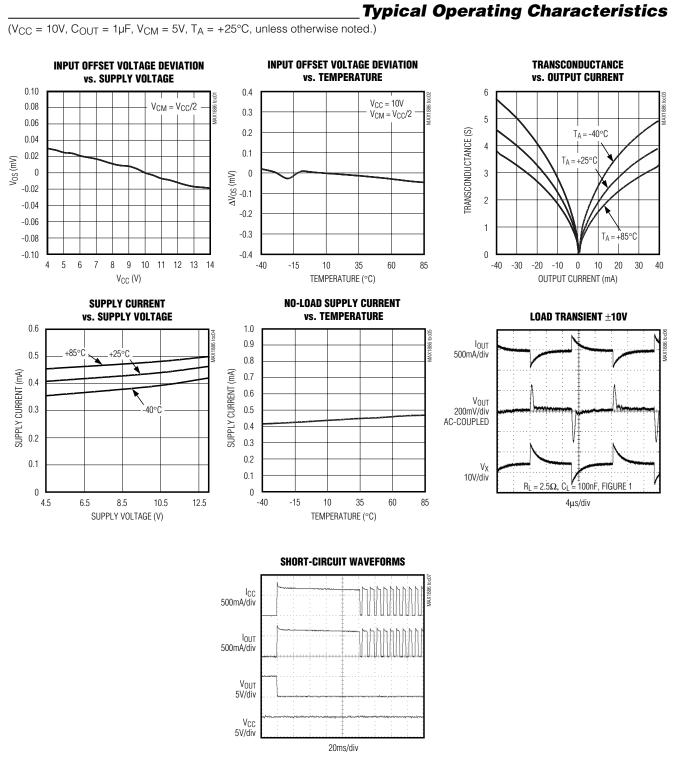


Figure 1. Load Transient Test Circuit

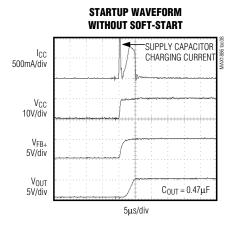


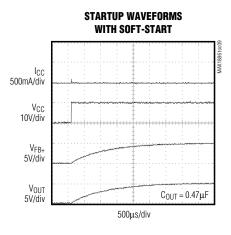
MAX1886

///XI//

Typical Operating Characteristics (continued)

 $(V_{CC} = 10V, C_{OUT} = 1\mu F, V_{CM} = 5V, T_A = +25^{\circ}C, unless otherwise noted.)$





Pin Description

PIN	NAME	DESCRIPTION
1	OUT	Output of Buffer Amplifier. Requires a minimum 0.47µF ceramic filter capacitor to GND. Place the capacitor close to OUT.
2	GND	Ground
3	V _{CC}	Voltage-Supply Input. Bypass to GND with a 0.47µF capacitor close to the pin. Use the output capacitor of the preceding voltage regulator as the additional filter capacitor.
4	FB+	Noninverting Input to Buffer Amplifier
5	FB-	Inverting Input to Buffer Amplifier. Feedback must be taken from the output filter capacitor terminal.

Detailed Description

The MAX1886 operational transconductance amplifier (OTA) provides high-current output that is ideal for driving capacitive loads such as the backplane of a TFT LCD panel. The positive feedback input, FB+, allows common-mode biasing to mid-supply, or other VCOM voltage.

The MAX1886 unity-gain bandwidth is GBW = g_m/C_{OUT} where g_m is the amplifier's transconductance. Transconductance is the ratio of the output current to the input voltage. The gain of the amplifier is dependent upon the load. The MAX1886 requires only a small 0.47µF ceramic output capacitor for stability. The bandwidth is inversely proportional to the output capacitor, so large capacitive loads improve stability; however, lower bandwidth decreases the buffer's transient response time. To improve the transient response times, the MAX1886's transconductance increases as the output current increases (see *Typical Operating Characteristics*).

Applications Information

Output Filter Capacitor

The MAX1886 requires a minimum of 0.47μ F output capacitance placed close to OUT. To ensure buffer stability, the output capacitor ESR must be 50m Ω or lower. Ceramic capacitors are an excellent choice.

Input Bypass Capacitor

The MAX1886 requires a 0.47 μ F input bypass capacitor (C2) close to the V_{CC} supply input (see Figure 2). Place the MAX1886 close to the preceding voltage regulator output capacitor so that the MAX1886 shares the same capacitor (C1). Minimize trace length and use wide



MAX1886

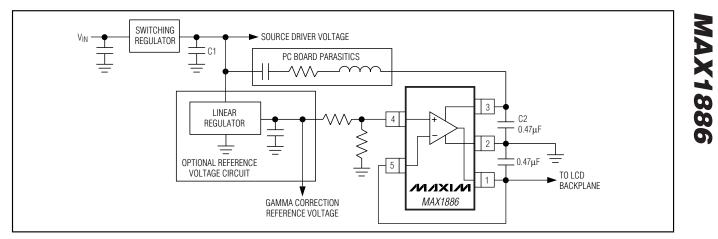


Figure 2. Typical TFT LCD Backplane Drive Circuit

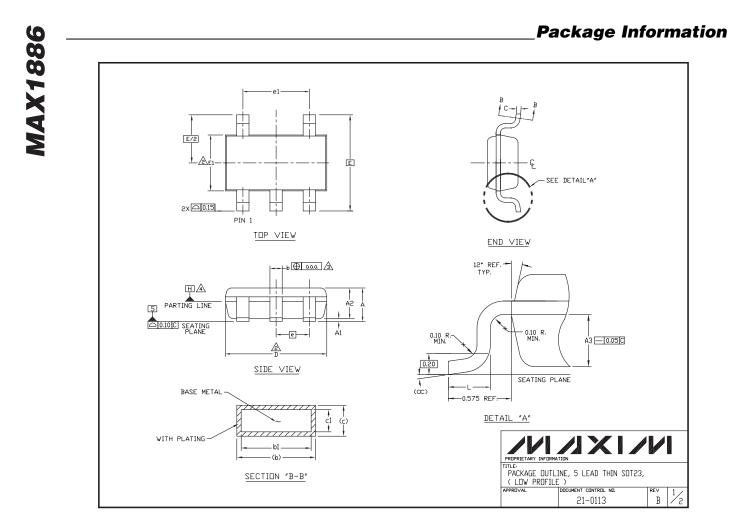
traces between the voltage regulator output and the MAX1886 V_{CC} input to reduce PC board parasitics (inductance, resistance, and capacitance), which can cause undesired ringing.

Voltage Reference

The reference voltage for the MAX1886 input can be produced using the output of a linear regulator. The linear regulator will reject the ripple voltage produced by the source drivers (see Figure 2). The output of this linear regulator can also be used for the gamma correction reference voltage.

Chip Information

TRANSISTOR COUNT: 121 PROCESS: BICMOS



Package Information (continued)

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- "D" AND "E1" ARE REFERENCE DATUM AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, AND ARE MEASURED AT THE BOTTOM PARTING LINE. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15mm ON "D" AND 0.25mm ON "E" PER SIDE.
- THE LEAD WIDTH DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.07mm TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION.
- A DATUM PLANE "H" LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT THE BOTTOM OF PARTING LINE.
- THE LEAD TIPS MUST LINE WITHIN A SPECIFIED TOLERANCE ZONE. THIS TOLERANCE ZONE IS DEFINED BY TWO PARALLEL LINES. ONE PLANE IS THE SEATING PLANE, DATUM [-C-]; AND THE OTHER PLANE IS AT THE SPECIFIED DISTANCE FROM [-C-] IN THE DIRECTION INDICATED. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITH 0.10mm AT SEATING PLANE.
- 6. THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-193 EXCEPT FOR THE "e" DIMENSION WHICH IS 0.95Mmm INSTEAD OF 1.00mm. THIS PART IS IN FULL COMPLIANCE TO EIAJ SPECIFICATION SC-74.

	SYM	BOLS	
	MIN	NDM	MAX
A	-	-	1.10
A1	0.05	0.075	0.10
A2	0.85	0.88	0.90
A3		0.50 BSC	
b	0.30	-	0.45
b1	0.25	0.35	0.40
С	0.15	-	0.20
⊂1	0.12	0.127	0.15
D	2.80	2.90	3.00
E		2.75 BSC	
E1	1.55	1.60	1.65
L	0.30	0.40	0.50
e1		1.90 BSC	
e		0.95 BSC	
œ	0-	4-	8-
ممم		0.20	



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600 _

is a registered trademark of Maxim Integrated Products.

7

MAX				SITE	PART NO
IAT'S NEW PR	ODUCTS	SOLUTIONS	DESIGN APPNOTES SUPPOR	T BUY	COMPANY MEMBERS
			MAX1886		
			Part Number Table		
Notes:					
 Other op Didn't Fione buside Part num full data * Some 	otions and nd What Y ness day. nber suffix sheet or F	ou Need? Ask es: T or T&R Part Naming C	nasing parts are listed at: http://ww our applications engineers. Expert a = tape and reel; + = RoHS/lead-fre	e; # = RoHS/lead	g parts, usually within -exempt. More: See
product					
product Part Number	uses.	ble Buy Direct	Package: TYPE PINS SIZE DRAWING CODE/VAR	Temp	RoHS/Lead-Free? Materials Analysis
Part Number	uses.				
Part Number MAX1886EUK	Free Samp				Materials Analysis
Part Number MAX1886EUK MAX1886EUK-	Free Samp			*	Materials Analysis RoHS/Lead-Free: No RoHS/Lead-Free: No
Part Number MAX1886EUK MAX1886EUK- MAX1886EZK+	Free Samp		DRAWING CODE/VAR SOT-23;5 pin;1.0 mm ht. Dwg: 21-0113C (PDF)	-40C to +85C	Materials Analysis RoHS/Lead-Free: No RoHS/Lead-Free: No RoHS/Lead-Free: Yes
	r		DRAWING CODE/VAR SOT-23;5 pin;1.0 mm ht. Dwg: 21-0113C (PDF) Use pkgcode/variation: Z5+1* SOT-23;5 pin;1.0 mm ht. Dwg: 21-0113C (PDF)	-40C to +85C -40C to +85C	Materials Analysis RoHS/Lead-Free: No RoHS/Lead-Free: No RoHS/Lead-Free: Yes Materials Analysis RoHS/Lead-Free: No

CONTACT US: SEND US AN EMAIL

Copyright 2007 by Maxim Integrated Products, Dallas Semiconductor • Legal Notices • Privacy Policy